

Product / Process Change Notification



N° 2014-134-A

Dear Customer,

Please find attached our INFINEON Technologies PCN:

Introduction of additional wafer fab and wafer test location in Kulim affecting TLE8444SL, TLE84106EL and TLE84110EL

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before **11th November 2016**.
- Infineon aligns with the widely-recognized JEDEC STANDARD “**JESD46**“, which stipulates: **“Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change.”**

Your prompt reply will help Infineon Technologies to assure a smooth and well executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.

Infineon Technologies AG
Postal Address Headquarters: Am Campeon 1-12, D-85579 Neubiberg, Phone +49 (0)89 234-0
Chairman of the Supervisory Board: Wolfgang Mayrhuber
Management Board: Dr. Reinhard Ploss (CEO), Dominik Asam, Dr. Helmut Gassel, Jochen Hanebeck
Registered Office: Neubiberg Commercial Register
Amtsgericht München HRB 126492

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► Products affected:

Sales Name	SP N°	OPN	Package
TLE8444SL	SP000394373	TLE8444SLXUMA1	PG-SSOP-24
TLE84106EL	SP000619116	TLE84106ELXUMA1	PG-SSOP-24
TLE84110EL	SP000670380	TLE84110ELXUMA1	PG-SSOP-24

► Detailed Change Information:

Subject: Introduction of additional wafer fab and wafer test location in Kulim affecting Infineon TLE8444SL, TLE84106EL and TLE84110EL.

Reason: Expansion of wafer production and wafer test capacity.
Due to continuously raising demand for Infineon automotive products we have to implement the well-known front end (FE) location Kulim as additional wafer fab and wafer test.

Description:	<u>Old</u>	<u>New</u>
Wafer fab location	■ Infineon Technologies AG, Regensburg, Germany	■ <u>Additional wafer fab location:</u> Infineon Technologies (Kulim) Sdn. Bhd, Kulim, Malaysia
Wafer test location	■ Infineon Technologies AG, Villach, Austria	■ <u>Additional wafer test location:</u> Infineon Technologies (Kulim) Sdn. Bhd, Kulim, Malaysia

► Product Identification: Wafer lot numbers from Regensburg start with RUxxxxxx.
Wafer lot numbers from Kulim with 1Exxxxxx.
Traceability assured via date code.
No change in SP ordering number.

► Impact of Change: Based on the qualification performed, Infineon does not see any negative impact on quality, function and reliability.
No change in fit and form.

► Attachments: N.A

► Time Schedule:

■ Final qualification report:	available
■ First samples available:	on request
■ Intended start of delivery:	01-April-2017 or earlier after customer release

If you have any questions, please do not hesitate to contact your local Sales office.